

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	257/692-697.cls.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/01/11 17:43
L2	0	257/692-697.cls.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2005/01/11 17:42
L3	4395	257/692-697.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/01/11 17:43
L4	751	3 and (solder near1 (bump ball))	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/01/11 17:44
L5	751	3 and (solder near (bump ball))	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/01/11 17:44
L6	1485	257/696	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/01/11 17:44
L7	264	L6 and (solder near (bump ball))	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/01/11 17:45
L8	600	5 not 7	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/01/11 17:45
L9	383	8 and (sealing encapsulant encapsulat\$3)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/01/11 17:45
L10	367	9 and (substrate pcb ((wiring circuit) near1 board))	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/01/11 18:45
L11	300	10 and lead	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/01/11 17:48
L12	5	("6054759").URPN.	USPAT	OR	ON	2005/01/11 17:58
L13	0	("6707140").URPN.	USPAT	OR	ON	2005/01/11 18:00
L14	20	("20010013645"   "5019673"   "5139969"   "5352926"   "5579208"   "5608262"   "5723369"   "5726079"   "5744827"   "5790384"   "5798567"   "5821615"   "5949135"   "6043430"   "6054759"   "6075284"   "6236109"   "6258630"   "6316837"   "6316838").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/01/11 18:00

L15	2	("5239198"   "5808357").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/01/11 18:03
L16	157	("5239198").URPN.	USPAT	OR	ON	2005/01/11 18:05
L17	22	("5563446").URPN.	USPAT	OR	ON	2005/01/11 18:11
L18	8	("4530002"   "4853757"   "4942454"   "5040035"   "5157480"   "5239198"   "5355016"   "5355283").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/01/11 18:12
L19	44	("5508556").URPN.	USPAT	OR	ON	2005/01/11 18:14
L20	9	("4530002"   "4558346"   "4700473"   "4975761"   "4992628"   "5157480"   "5220195"   "5239198"   "5281556").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/01/11 18:18
L21	8	("4264917"   "4647126"   "4807021"   "4922378"   "4967262"   "4975763"   "5018005"   "5095359").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/01/11 18:19
L22	21	("5648679").URPN.	USPAT	OR	ON	2005/01/11 18:25
L23	1	("5569955").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/01/11 18:34
L24	11	5 and (through near1 hole near1 lead)	US-PGPUB; USPAT; USOCR	OR	ON	2005/01/11 18:43
L25	500	(leadframe (lead adj frame)) and (through near2 hole near2 lead)	US-PGPUB; USPAT; USOCR	OR	ON	2005/01/11 18:44
L26	602	(leadframe (lead adj frame)) and (through near2 hole near2 lead)	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2005/01/11 19:04
L27	2256	(substrate pcb ((wiring circuit) near1 board)) with (pad near3 hole)	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/01/11 18:46
L28	18	26 and 27	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/01/11 18:46
L29	5178	(through near2 hole near2 lead)	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2005/01/11 19:04
L30	120	27 and 29	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2005/01/11 19:04

L31	1068	(lead near1 through near1 hole)	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2005/01/11 19:12
L32	26	27 and 31	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2005/01/11 19:12
L33	15	32 not 28	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2005/01/11 19:05
L34	4453	(lead near1 hole)	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2005/01/11 19:12
L35	64	27 and 34	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2005/01/11 19:12
L36	50	35 not 28 not 33	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2005/01/11 19:13
L37	8	("4914259").URPN.	USPAT	OR	ON	2005/01/11 19:20
L38	9	("4405971"   "4439815"   "4584767"   "4604799"   "4687695"   "4688328"   "4710419"   "4758459"   "4811482").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/01/11 19:20
L39	9	("4405971"   "4439815"   "4584767"   "4604799"   "4687695"   "4688328"   "4710419"   "4758459"   "4811482").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/01/11 19:22